



5 Gbp轨对轨低插入损耗开关

CBTL02GP023HO

Archived

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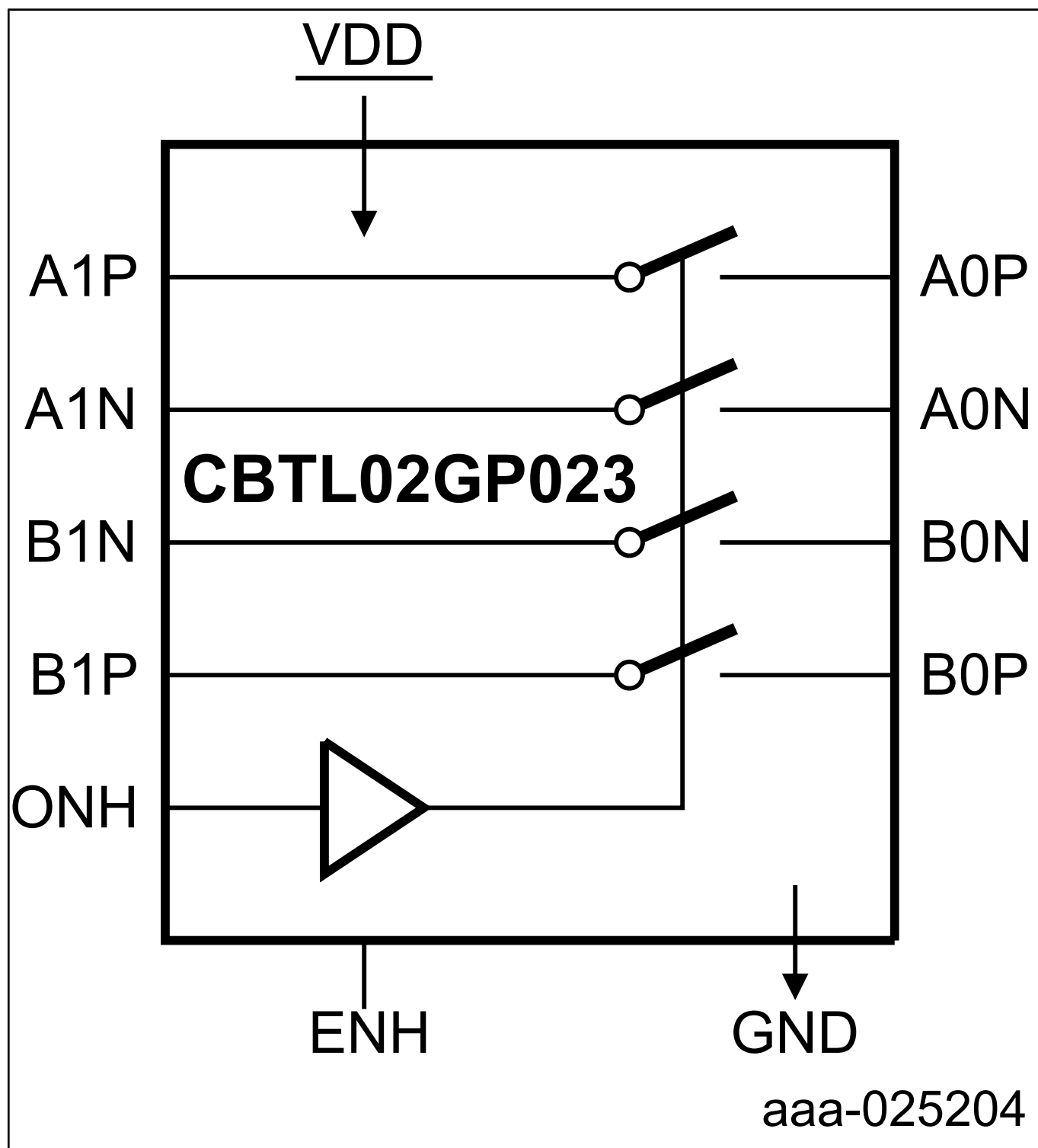
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CBTL02GP023是一款单端口高性能的5 Gbps轨对轨低插入损耗4x SPST开关芯片，经过优化，可连接USB3.0信号与高电压(例如USB2信号)隔离。它在Dongle或插头应用中支持5 Gbps USB3.0信号和大摆幅USB2或UART信号。它也可以用作其他应用中的通用5 Gbps轨对轨低插入损耗开关芯片。

所有输入或输出引脚的共模电压具有从0 V到VDD的宽共模范围。

CBTL02GP023为1.5 mm x 2.1 mm x 0.32 mm规格的DHX2QFN14封装，间距为0.4 mm。

CBTL02GP023 Block Diagram Block Diagram



View additional information for [5 Gbp轨对轨低插入损耗开关](#).

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